Advanced Power MOSFET

IRLSZ44A

FEATURES

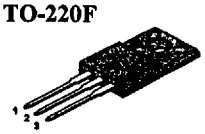
- Logic Level Gate Drive
- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- Lower Leakage Current : 10 μA (Max.) @ V_{DS} = 60V
- Lower $R_{DS(ON)}$: 0.02 Ω (Typ.)

BV_{DSS} = 60 V

$R_{DS(on)}$ = 0.025 Ω

I_D = 30 A

TO-220F



1.Gate 2. Drain 3. Source

Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
V_{DSS}	Drain-to-Source Voltage	60	V
I_D	Continuous Drain Current (T_C=25 °C)	30	A
	Continuous Drain Current (T_C=100 °C)	21	
I_{DM}	Drain Current-Pulsed ①	120	A
V_{GS}	Gate-to-Source Voltage	±20	V
E_{AS}	Single Pulsed Avalanche Energy ②	771	mJ
I_{AR}	Avalanche Current ①	30	A
E_{AR}	Repetitive Avalanche Energy ①	4.5	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.5	V/ns
P_D	Total Power Dissipation (T_C=25°C)	45	W
	Linear Derating Factor	0.3	W/°C
T_J , T_{STG}	Operating Junction and Storage Temperature Range	- 55 to +175	°C
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5-seconds	300	

Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	–	3.33	°C/W
$R_{\theta JA}$	Junction-to-Ambient	–	62.5	

SAMSUNG ELECTRONICS

Electrical Characteristics (T_C=25°C unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
BV_{DSS}	Drain-Source Breakdown Voltage	60	--	--	V	V_{GS}=0V, I_D=250 μA
$\Delta BV/\Delta T_J$	Breakdown Voltage Temp. Coeff.	--	0.056	--	V/°C	I_D=250 μA *See Fig 7*
$V_{GS(th)}$	Gate Threshold Voltage	1.0	--	2.0	V	V_{DS}=5V, I_D=250 μA
I_{GSS}	Gate-Source Leakage , Forward	--	--	100	nA	V_{GS}=20V
	Gate-Source Leakage , Reverse	--	--	-100		V_{GS}=-20V
I_{DSS}	Drain-to-Source Leakage Current	--	--	10	μA	V_{DS}=60V
		--	--	100		V_{DS}=48V, T_C=150°C
$R_{DS(on)}$	Static Drain-Source On-State Resistance	--	--	0.025	Ω	V_{GS}=5V, I_D=15A ④
g_{fs}	Forward Transconductance	--	33	--	℧	V_{DS}=30V, I_D=15A ④
C_{iss}	Input Capacitance	--	1530	1990	pF	V_{GS}=0V, V_{DS}=25V, f =1MHz *See Fig 5*
C_{oss}	Output Capacitance	--	555	640		
C_{rss}	Reverse Transfer Capacitance	--	225	260		
$t_{d(on)}$	Turn-On Delay Time	--	14	40	ns	V_{DD}=30V, I_D=50A, R_G=4.6 Ω *See Fig 13* ④ ⑤
t_r	Rise Time	--	24	60		
$t_{d(off)}$	Turn-Off Delay Time	--	43	95		
t_f	Fall Time	--	37	85		
Q_g	Total Gate Charge	--	42	55	nC	V_{DS}=48V, V_{GS}=5V, I_D=50A *See Fig 6 & Fig 12* ④ ⑤
Q_{gs}	Gate-Source Charge	--	12	--		
Q_{gd}	Gate-Drain("Miller") Charge	--	20	--		

Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
I_S	Continuous Source Current	--	--	30	A	Integral reverse pn-diode in the MOSFET
I_{SM}	Pulsed-Source Current ①	--	--	120		
V_{SD}	Diode Forward Voltage ④	--	--	1.8	V	T_J=25 °C, I_S=30A, V_{GS}=0V
t_{rr}	Reverse Recovery Time	--	72	--	ns	T_J=25 °C, I_F=50A
Q_{rr}	Reverse Recovery Charge	--	0.133	--	μC	di_F/dt=100A/μs ④

Notes ;

① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature
② L=1mH, I_{AS}=30A, V_{DD}=25V, R_G=27Ω, Starting T_J=25 °C
③ I_{SD} ≤ 50A, di/dt ≤ 350A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J=25 °C
④ Pulse Test : Pulse Width = 250 μs, Duty Cycle ≤ 2%
⑤ Essentially Independent of Operating Temperature

Fig 1. Output Characteristics

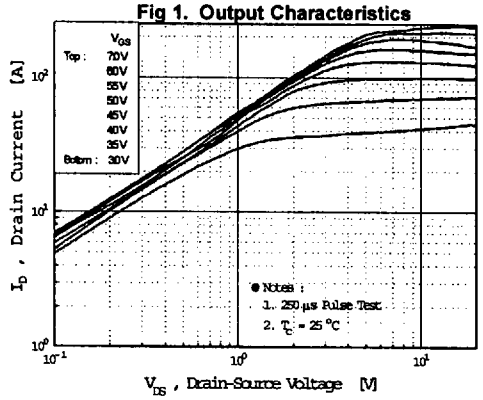


Fig 2. Transfer Characteristics

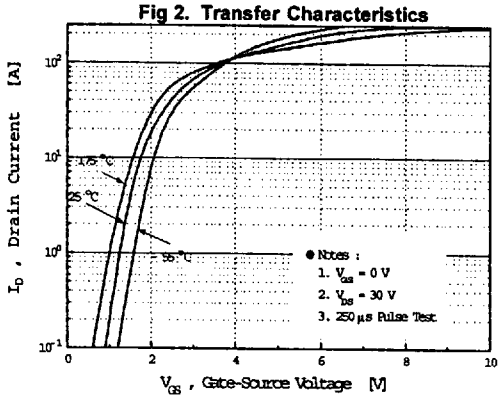


Fig 3. On-Resistance vs. Drain Current

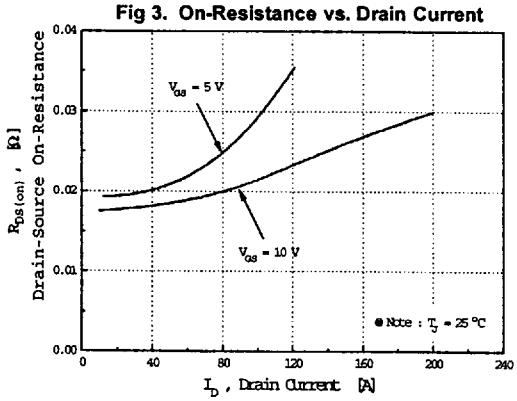


Fig 4. Source-Drain Diode Forward Voltage

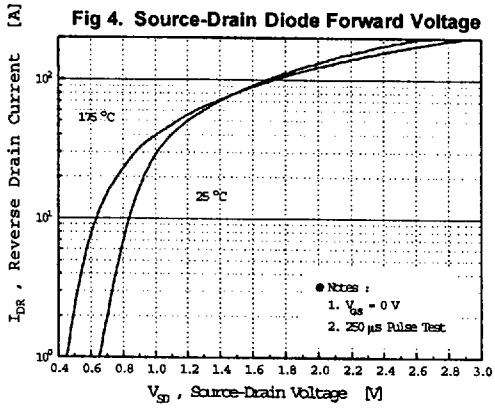


Fig 5. Capacitance vs. Drain-Source Voltage

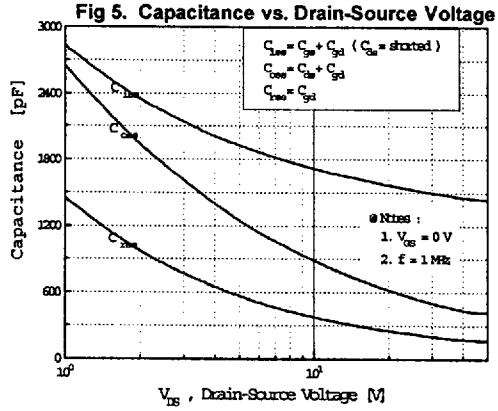


Fig 6. Gate Charge vs. Gate-Source Voltage

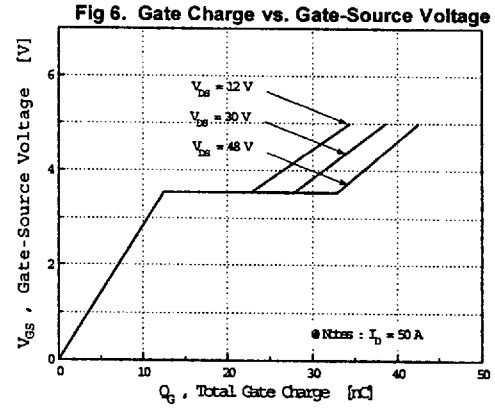


Fig 7. Breakdown Voltage vs. Temperature

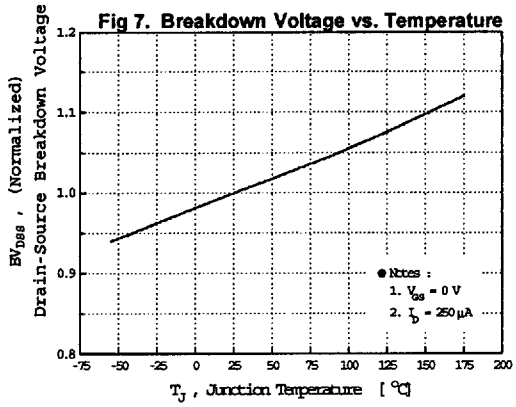


Fig 8. On-Resistance vs. Temperature

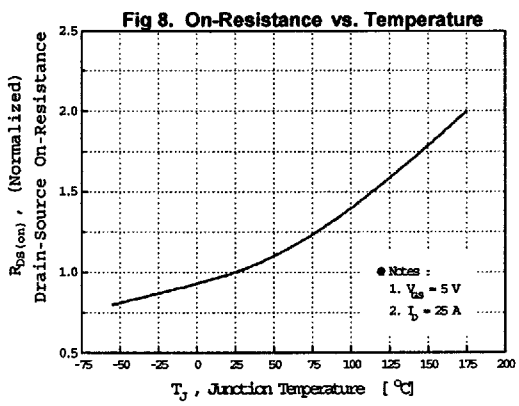


Fig 9. Max. Safe Operating Area

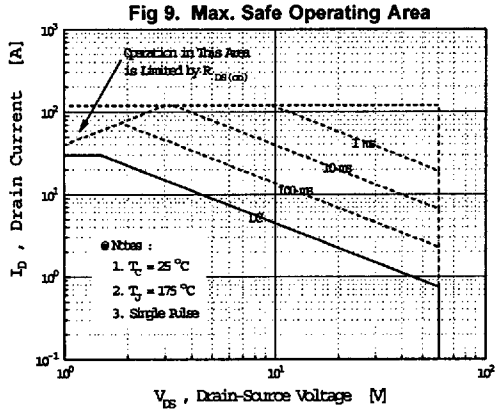


Fig 10. Max. Drain Current vs. Case Temperature

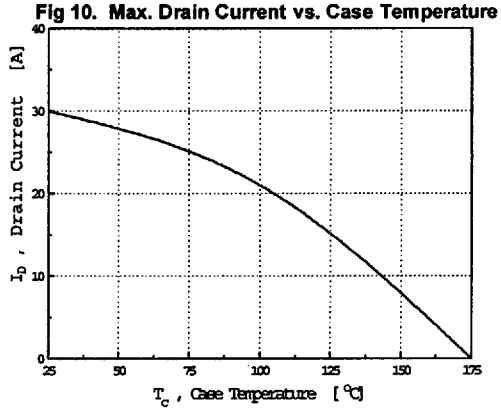


Fig 11. Thermal Response

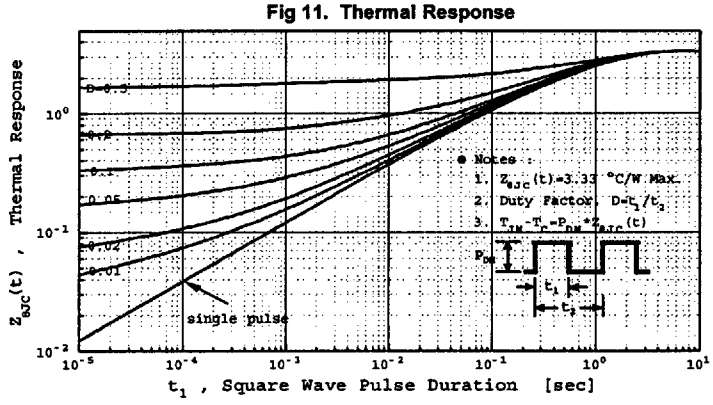


Fig 12. Gate Charge Test Circuit & Waveform

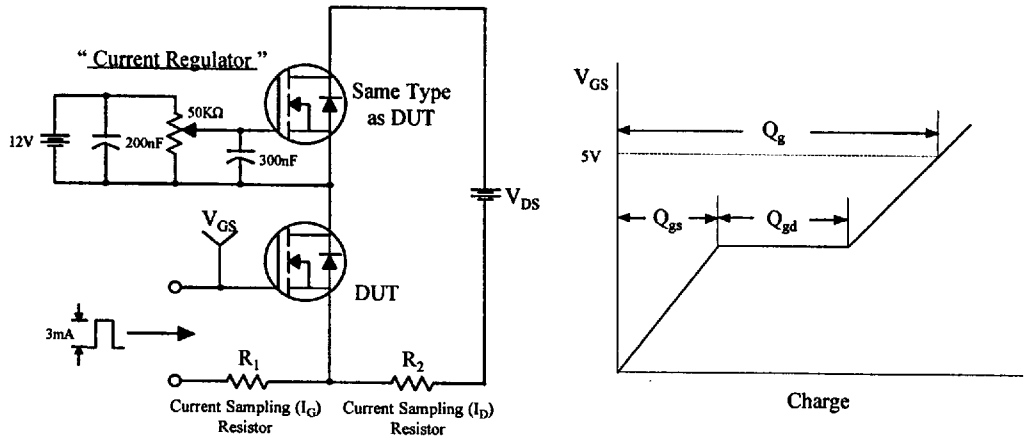


Fig 13. Resistive Switching Test Circuit & Waveforms

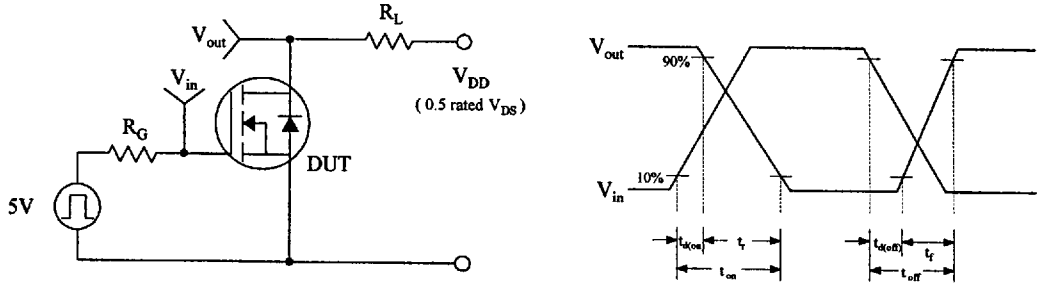


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

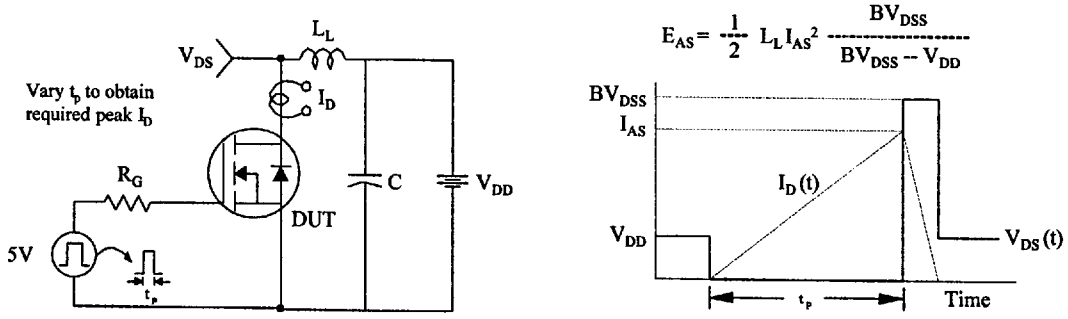


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms